

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(conductive adj resin and ceramic)same (substrate and electrical\$2 adj shield and encapsulat\$3)	US-PGPUB; USPAT	ADJ	ON	2008/03/14 15:21
L2	0	(conductive adj resin and ceramic)same (substrate and electrical\$2 adj shield and encapsulat\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:21
L3	0	(conductive adj resin and ceramic)same (substrate shield and encapsulat\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:22
L4	0	(conductive adj resin and ceramic)and (substrate shield and encapsulat\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:22
L5	2345	(conductive adj resin and ceramic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:22
L6	6	(conductive adj resin and ceramic)substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:22
L7	1634	(conductive adj resin and ceramic)and substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:22
L8	925	(conductive adj resin and ceramic)and substrate and (encapsulat\$3 or seal\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/14 15:23
L9	23	"6734542"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 15:56
L10	2	"6815810"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 15:59
L22	371	361/814.ccls.	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:05

L23	243	361/814.ccls. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:06
L24	1	encapsulat\$3 and substrate and chip and 361/814.ccls. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:06
L25	3	encapsulat\$3 and substrate and 361/814.ccls. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:06
L26	9	encapsulat\$3 and board and 361/814.ccls. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:06
L27	66	encapsulat\$3 and board and 361/818.ccls. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:07
L28	79	encapsulat\$3 and 361/818.ccls. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:08
L29	4236	encapsulat\$3 and "361". clas. and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/14 17:08
S805	4	"549996".ap.	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 15:36
S806	1378	257/e23.114.ccls.	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 16:06
S807	927	257/e23.114.ccls. and @ad<"20030825"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 16:14
S808	38993	(ceramic or alumina) with (resin or polymer) with (conductive or steel or metal or nickel or copper)	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 21:11
S809	1942	(partition or shield or wall or isolation)(ceramic or alumina) with (resin or polymer) with (conductive or steel or metal or nickel or copper)	US-PGPUB; USPAT; USOCR; FPRS	SAME	ON	2008/03/13 21:18
S810	228	(partition or shield or wall or isolation)same (ceramic or alumina) (resin or polymer) (conductive or steel or metal or nickel or copper)	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2008/03/13 21:19
S811	157	(partition or shield or wall or isolation)same (ceramic or alumina) (resin or polymer) (conductive or steel or metal or nickel or copper)and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2008/03/13 21:20

S812	58	module same (ceramic or alumina) (resin or polymer) (conductive or steel or metal or nickel or copper) and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2008/03/13 21:23
S813	63	module same (ceramic or alumina) (resin or polymer) (conductive or steel or metal or nickel or copper) and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2008/03/13 21:24
S814	86	module same (ceramic or alumina) (resin or polymer) (conductive or steel or metal or nickel or copper)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2008/03/13 21:25
S815	0	"tsuneoka-michiaki-in."	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 21:27
S816	0	"tsuneoka-michiaki.in."	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 21:28
S817	0	"tsuneoka.in."	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2008/03/13 21:28
S818	0	"tsuneoka.in."	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 21:28
S819	971663	module	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 21:28
S820	203728	module.ti.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 21:28
S821	125	module adj part.ti.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 21:29
S822	375	257/660.cds.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 21:38

3/ 14/ 2008 5:17:31 PM

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